

# Emerging Technologies in Contact Thermometry

Emerging Technologies Task group

# Task group's Mission

## TERMS:

The terms of reference of the CCT-TG-CTh-ET are to identify, study and advise the CCT on matters related to the areas of emerging technologies.

## TASKS:

- Review the field and report to the CCT on various emergent technologies for contact thermometry devices and measurement techniques; (*Table 1 and 2*)
- Review and report on published data from various emergent technologies including a comparative study of the advantages (*Table 1 and 2*), limitations (*Table 1 and 2*), materials (*section 3.4.2 and table 1*), and temperature ranges (*Table 1 and section 3.1,3.2, 3.3, 3.4.3, 3.5, 4.1 and 4.2*);
- Review and report on the potential of some of these emergent technologies for primary thermometry (*Table 1, section 3.1, 3.2, 3.5, 4.2*)

# Task group's Membership

Dr. Zeeshan Ahmed (chairperson, NIST)

- Prof. Stéphan Briaudeau (LNE-Cnam)
- Dr Sergey Dedyulin (NRC)
- Dr Efrem Kebede Ejigu (NMISA)
- Prof. Vito Farnicola (INRIM)
- Dr Victor Fuksov (VNIIM)
- Dr Maria-José Martín Hernández (CEM),
- Dr Murat Kalemci (UME)
- Ing. Tomas Kopunec (SMU)
- Dr Stephan Krenek (PTB)
- Dr Sergey Osadchiy (VNIIFTRI),
- Prof. Graham Machin (NPL)
- Dr Yijie Pan (NIM, observer)
- Dr Jifeng Qu (NIM)
- Dr Chiharu Urano (NMIJ/AIST)
- Dr Eric van der Ham (NMIA)
- Dr Li Wang (NMC, A\*STAR)
- Prof. Dr Davor Zvizdic (FSB-LPM)

(past members)

- Steffen Rudtsch (PTB)
- Michael de Podesta (NPL)
- Dr Dolores del Campo Maldonado (CEM)
- Edgar Mendez (CENAM)
- Andrea Peruzzi (VSL)
- Dr Martti Heinonen (MIKES)
- Dr Farzana Masouleh (MSL)
- Dr Dolores Del Campo (CEM)

# Technology Landscape: Possible Realities

## Primary Thermometers:

- Optomechanical Thermometry
- Refractometry based Thermometry
- On-chip Doppler Broadening Thermometry

## ITS 90 Traceable Thermometry

- Optical thermometry
- Photonic Thermometry
  - Light scattering
  - Refractometry
    - In-Fiber
    - On-Chip

## New Technologies and Trends

- NV diamond and Quantum Dots
- Rydberg Atoms
- Photonic Interrogator

A detailed review paper covering a broader range of technologies, discussed in greater depth was published.

Along with the report it provides a detailed map of the literature to any new user interested in emerging technologies in contact thermometry

# Emerging technologies Vs. State of the Art (Table 1)

Table 1: Emerging technologies in thermometry compared to standard platinum resistance thermometer (SPRT) and type S thermocouple

Technology	Primary	Probe Material	Sensitive Element Size	Temperature Range	Typical Sensitivity	Expected Uncertainty	Commercial
On-chip DBT	y	Rb/Cs	0.1 mm <sup>3</sup>	300 K - 1000 K	0.8 Hz/Torr/K	0.1 mK - 100 mK	n
FBG	n	SiO <sub>2</sub> <sup>a</sup>	0.1 mm - 10 mm	80 K - 1300 K	10 pm/K <sup>b</sup>	100 mK - 500 mK	y
Brillouin Scattering	n	SiO <sub>2</sub>	0.1 m - 100 m	250 K - 350 K <sup>c</sup>	1 MHz/K	0.5 K - 10 K	y
Raman Scattering	y	SiO <sub>2</sub>	0.001 m - 10 m	250 K - 350 K	—	0.01 K - 10 K	y
Ring Resonator/Photonic Crystal Cavity	n	Si <sup>d</sup>	0.1 mm - 1 mm	3 K - 1000 K	100 pm/K <sup>b</sup>	1 mK - 100 mK	n
Optomechanical Thermometry	y	Si <sub>3</sub> N <sub>4</sub> /Si	0.1 mm - 1 mm	0.05 K - 300 K	60 pm/K	1 K - 10 K	n
Long-Stem SPRT	n	Pt	40 mm - 60 mm	75 K - 950 K	0.1 Ω/K	0.1 mK - 1 mK	y
Type S Thermocouple	n	Pt(Rh)	0.5 m - 1 m	300 K - 2000 K	10 μV/K	100 mK - 500 mK	y

<sup>a</sup> Fiber Bragg grating can be inscribed in sapphire (Al<sub>2</sub>O<sub>3</sub>) in which case the temperature range can be extended to 2000 K.

<sup>b</sup> Typical resolution of a tunable laser used for interrogation is 0.1 pm.

<sup>c</sup> The range can be potentially extended to 1 K - 1100 K.

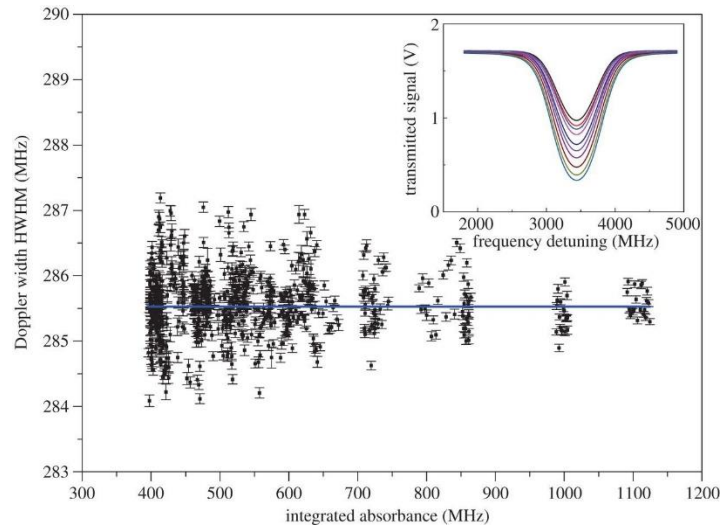
<sup>d</sup> See Section 3 for complete list of materials.

# Why and Why Not of Emerging Technologies (Table 2)

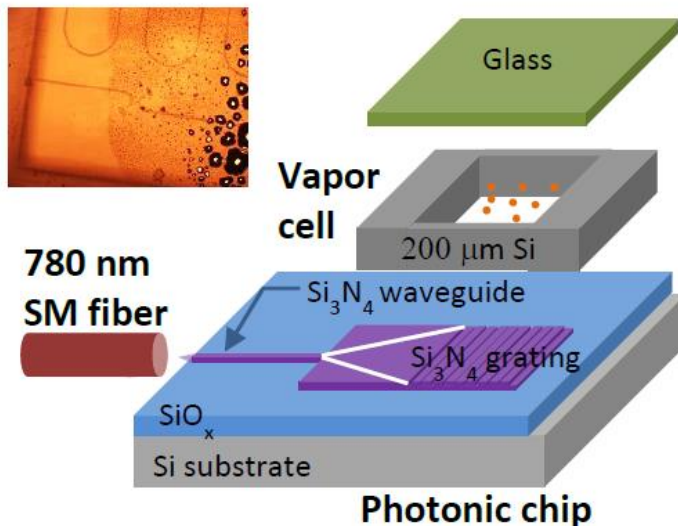
Table 2: Advantages and drawbacks of emerging technologies described in Table

Technology	Advantages	Drawbacks
Optical Refraction	<ul style="list-style-type: none"> <li>✓ Measures thermodynamic temperature (traceable to frequency and pressure)</li> </ul>	<ul style="list-style-type: none"> <li>× Centimeter scale footprint</li> <li>× Working gas is susceptible to chemical contamination</li> <li>× Limited to temperatures below 150 °C (mirror coating)</li> </ul>
On-chip DBT	<ul style="list-style-type: none"> <li>✓ Measures thermodynamic temperature (traceable to frequency)</li> </ul>	<ul style="list-style-type: none"> <li>× Susceptible to magnetic field</li> </ul>
FBG	<ul style="list-style-type: none"> <li>✓ Packaging is compatible with the existing calibration infrastructure</li> <li>✓ Point-like temperature sensor</li> <li>✓ Multi-point sensing capability (singal multiplexing)</li> </ul>	<ul style="list-style-type: none"> <li>× Thermal hysteresis, long-term drifts are not well understood</li> <li>× Susceptible to ionizing radiation</li> <li>× Cross-sensitivity (stress, humidity)</li> </ul>
Brilloiuin/Raman Scattering	<ul style="list-style-type: none"> <li>✓ Spatial range covers several orders of magnitude (cm to km)</li> <li>✓ Suitable for static and dynamic measurements</li> <li>✓ Resistant to ionizing radiation and chemical corrosion</li> <li>✓ Measures thermodynamic temperature (single photon detector)</li> </ul>	<ul style="list-style-type: none"> <li>× Lower accuracy compared to the most common temperature sensors</li> <li>× Susceptible to strain; special device handling and installation protocol are necessary</li> <li>× Detection systems are often complex and expensive (increased training time)</li> </ul>
Optical resonators	<ul style="list-style-type: none"> <li>✓ Smallest uncertainty / resolution compared to other emerging technologies; expected uncertainties comparable to SPRT</li> <li>✓ Wide range of materials, wavelengths and device design parameters available for fit-for-purpose device development</li> </ul>	<ul style="list-style-type: none"> <li>× Low-drift packaging needs to be developed</li> <li>× High-temperature packaging needs to be developed</li> <li>× Manufacturing imperfections contribute to device-to-device variability</li> </ul>
Optomechanics thermometry	<ul style="list-style-type: none"> <li>✓ On-chip thermodynamic temperature</li> <li>✓ Integrateable with on-chip photonic thermometers</li> </ul>	<ul style="list-style-type: none"> <li>× Early stage of research</li> <li>× Uncertainties estimated to be on the order of 1 K</li> </ul>

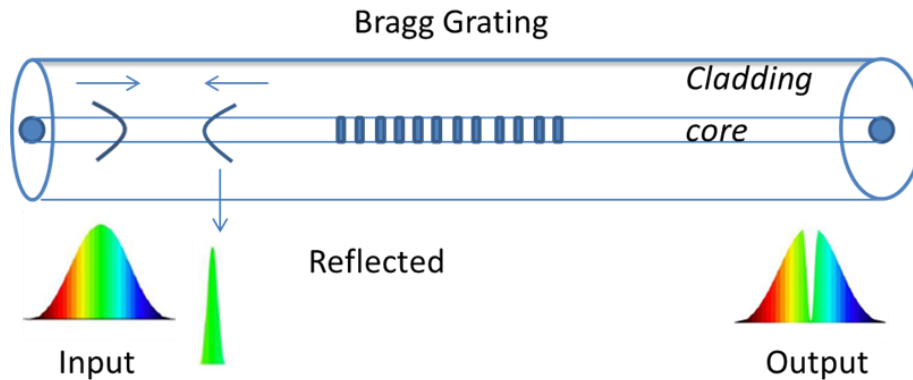
# On-Chip Doppler Broadening Thermometer



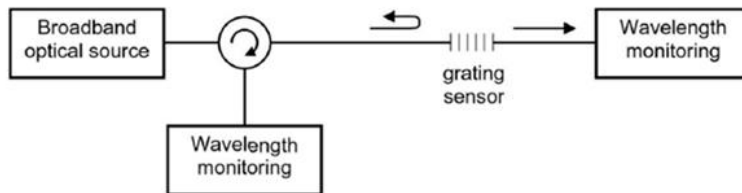
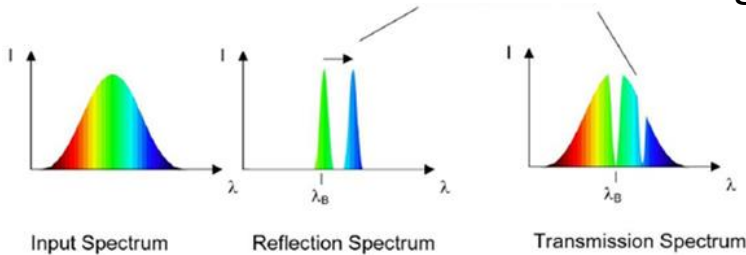
- Molecular spectroscopy-based Quantum SI realization
- Builds on history of free space DBT work
- Expected Uncertainty: 0.1 mK - 100 mK
- Advantages:
  - Thermodynamic Temperature
  - Small chip scale footprint
- Disadvantages:
  - Uncertainties likely to be in the 100 ppm
  - Susceptible to magnetic fields
- Thermalization of atomic vapour in nano-volume requires greater scrutiny; wall effects need to be quantified
- ETA: 5+ years



# Fiber Optic based Thermometry



Temperature or Strain induced shift in wavelength



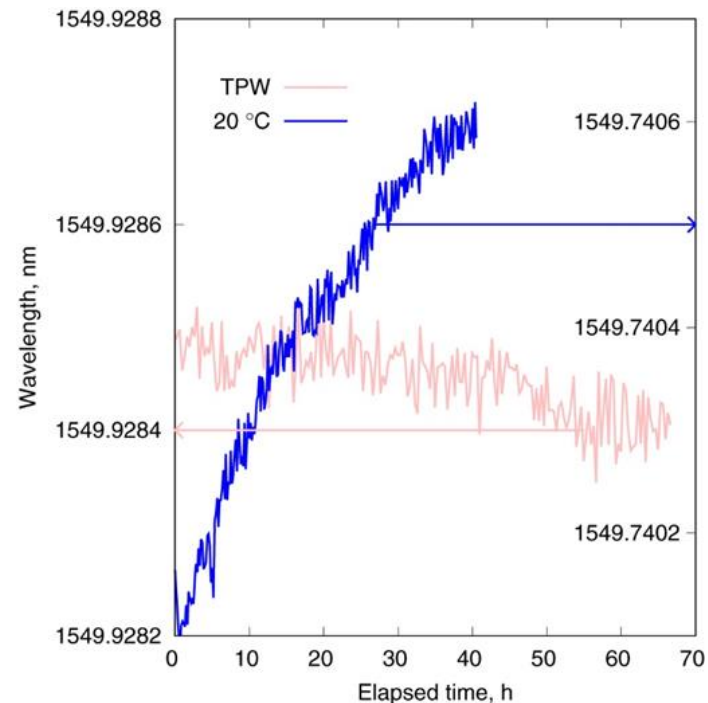
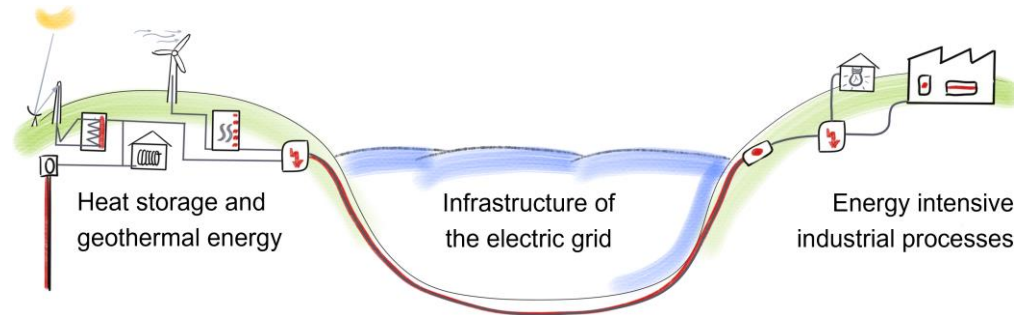
- Refractive index-based temperature transduction to frequency
- Expected Uncertainty: 100 mK – 500 mK
- Advantages:
  - Packaging can be made compatible with existing infrastructure
  - Point source-like temperature sensor
  - Multipoint sensing capability
  - Widely in use in telecom and sensor community
  - Large temperature range (100 K -1500 K) with sapphire fiber ( $\alpha = 1 \text{ K} - 5\text{K}$ )
  - ITS-90 Temperature
  - Green Energy applications
- Disadvantages:
  - Thermal hysteresis, long-term drift not well understood
  - Susceptible to ionizing radiation
  - Cross-sensitivity to stress and moisture
  - Large footprint (millimeter scale)
- ETA: on-market



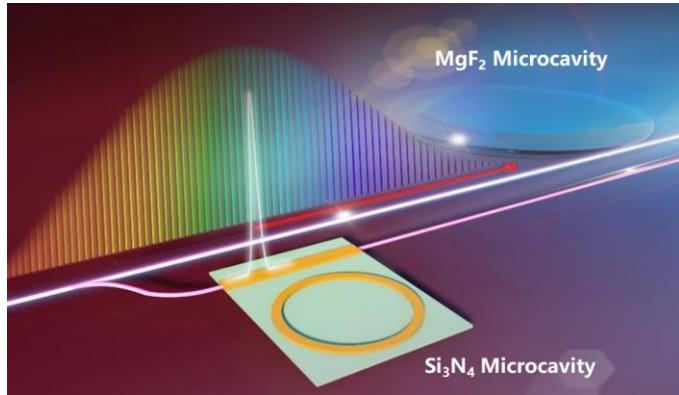
# What's holding back fiber thermometry?

Metrology specific understanding of device performance is *lacking*

- What's the uncertainty budget?
  - 100 mK - 10 K- depends upon grating type and temperature range
- What is the source of uncertainty?
  - Hysteresis
  - Peak center
  - Environment (e.g. moisture)
- Are these devices interchangeable?
- How stable are they?
- What's the measurement repeatability?
- The European INFOTerm project runs from 2023 to 2026 and aims to address several of these issues. ([www.infotherm.ptb.de](http://www.infotherm.ptb.de))



# On-Chip Thermometry

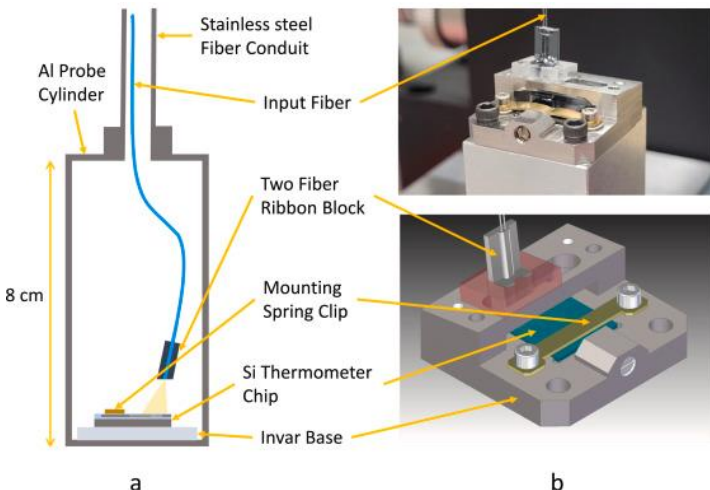


Jin Wang, Yijie Pan, Jifeng Qu, et al. Photonic Research, 11(2023),

- Refractive index-based temperature transduction to frequency
- Expected Uncertainty: 1 mK – 100 mK (*current: 9.2 mK*)
- Resolution floor:  $\leq 50 \mu\text{K}$
- Advantages:
  - Packaging can be made compatible with existing infrastructure
  - Point source-like temperature sensor
  - Large temperature range (cryogenic temps to  $>500 \text{ K}$ )
  - ITS-90 Temperature

- Disadvantages:
  - Thermal hysteresis/long-term drift not well understood; self-heating/non-linear effects limit accuracy
  - Accuracy under thermal gradients need to be understood
  - May be susceptible to ionizing radiation
  - Cross-sensitivity to stress and moisture (packaging dependent)
  - Interrogation instrument's C-SWAP could be limiting

Adoption of III-V materials could increase rad-hardness, increased sensitivity and ease PIC instrumentation development



# New Trends and Technologies

- NV diamond and Quantum Dots:
  - Finding utility in microscopy of biological and semi-conductor matrices.
  - Metrology specific questions similar to photonic thermometry need to be addressed
- Rydberg Atoms
  - Holds the promise of primary thermometry with uncertainties in the 1-4% range; immediate future depends on further development of spectroscopic and theoretical methods
- Photonic Interrogator:
  - The cost and complexity of photonic interrogator is likely to prove to be a limiting step in wider adoption of the technique. Development of fit-for-purpose, cost-effective solution will help accelerate technology adoption.

# Grand Challenges

*How do we bring the rigor of metrology to emerging technologies?*

How good are these devices? What are they good for?

What does temperature mean at the nanoscale?

*How do we communicate in a cross disciplinary field?*

Temperature, frequency, photonics, communication, QIS, humidity, ML

*How do we meet the user community where it is?*

C-SWAP, complexity of technology/training

# Au Revoir/Auf Wiedersehen/Good bye

- Deliverables:
  - Report concisely reports a survey on broad range of primary and ITS-90 relevant technologies
  - Report presents a comparative analysis of each technology's advantages and backdraws
  - Reports highlights the need for harmonization of measurement metrics and need for standards to promote these technologies
  - Report highlights trends and technologies to watch beyond the techniques extensively studied
    - Quantum technologies are continuing to evolve with new opportunities emerging e.g. NV diamond and quantum blackbody radiation thermometry
- Other noteworthy publications:
  - *Emerging technologies in the field of thermometry (and refs within)*  
<https://doi.org/10.1088/1361-6501/ac75b1>
  - Practical ring-resonator thermometer with an uncertainty of 10 mK  
<https://doi.org/10.1016/j.measurement.2023.113453>
  - Soliton microcomb-assisted microring photonic thermometer with ultra-high resolution and broad range  
<https://doi.org/10.1364/PRJ.496232>
  - Photonic contact thermometry using silicon ring resonators and tuneable laser-based spectroscopy  
<https://doi.org/10.1515/teme-2021-0054>
- That taskgroup has completed its task and will be shutdown down.